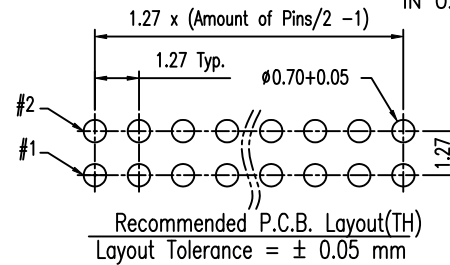


NOTE:

1. MATERIAL,  
HOUSING: HIGH TEMP THERMAL PLASTIC, UL94-V0  
TERMINAL: COPPER ALLOY
2. FINISH:  
TERMINAL: GOLD AT CONTACT,  
G/F OVER 1UM(40U")MIN Ni OVER ALL
3. SPEC.:  
PRODUCT SPEC: GS-12-629  
PACKING SPEC: GS-14-1517
4. THE HSG. WILL WITHSTAND EXPOSURE TO 260C  
PEAK TEMP. FOR 10 SEC. IN A WAVE SOLDER APPLICATION.
5. MATING SIDE LENGTH: 2.5MM MIN.
6. PRODUCT NUMBERING:  
200218 24 - XXX XX X X LF

LEAD FREE  
PLATING:  
1: G/F ALL OVER  
4: 0.25UM(10U")GOLD AT CONTACT  
8: 0.76UM(30U")GOLD AT CONTACT  
PACKING  
T: TUBE  
PIN COUNT  
04, 06, 08, ..., 98, A0  
( EVERY EVEN PIN )  
STACK HEIGHT "K"  
EXAMPLE: 045=4.5MM  
IN 0.5MM INCREMENT



mat'l. code		surface <input checked="" type="checkbox"/> tolerance		projection		product family 585	
ltr	ecn no	dr	date	tolerances unless otherwise specified		title	
A	T10-0182	S.LIN	10'-10-07	angles	linear	1.27X1.27MM BTB STACK HD VT, TH	
				0°±2'		MM	
						scale N/A	
		dr	STERLING LIN	10'-10'-05			
		eng	STERLING LIN	10'-10'-05			
		chr	STERLING LIN	10'-10'-05			
		app	GARY HSIEH	10'-10'-05			
sheet index	revision	A		sheet 1 of 1		size A4	
	sheet	1		type CUSTOMER		Drawing	